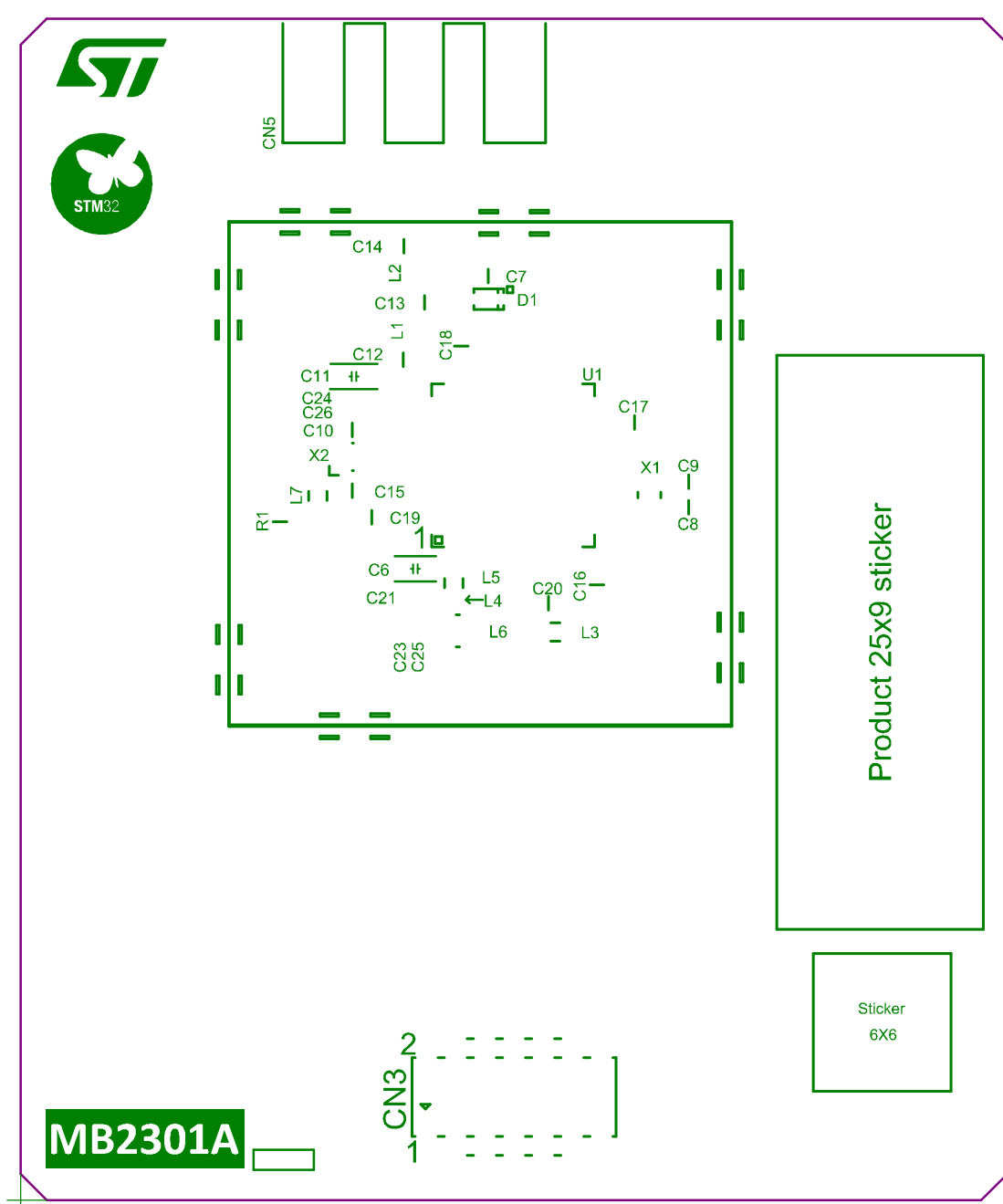
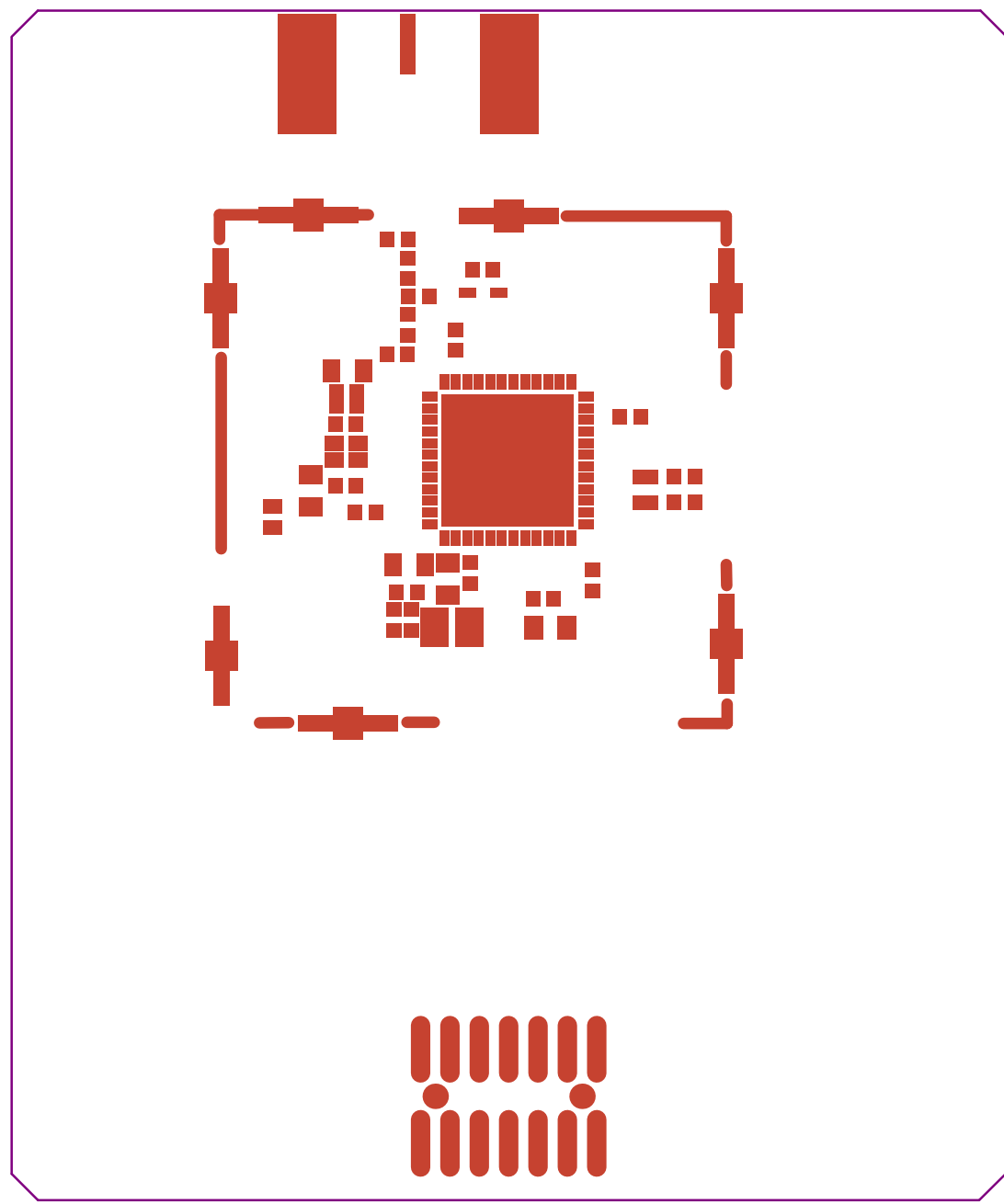
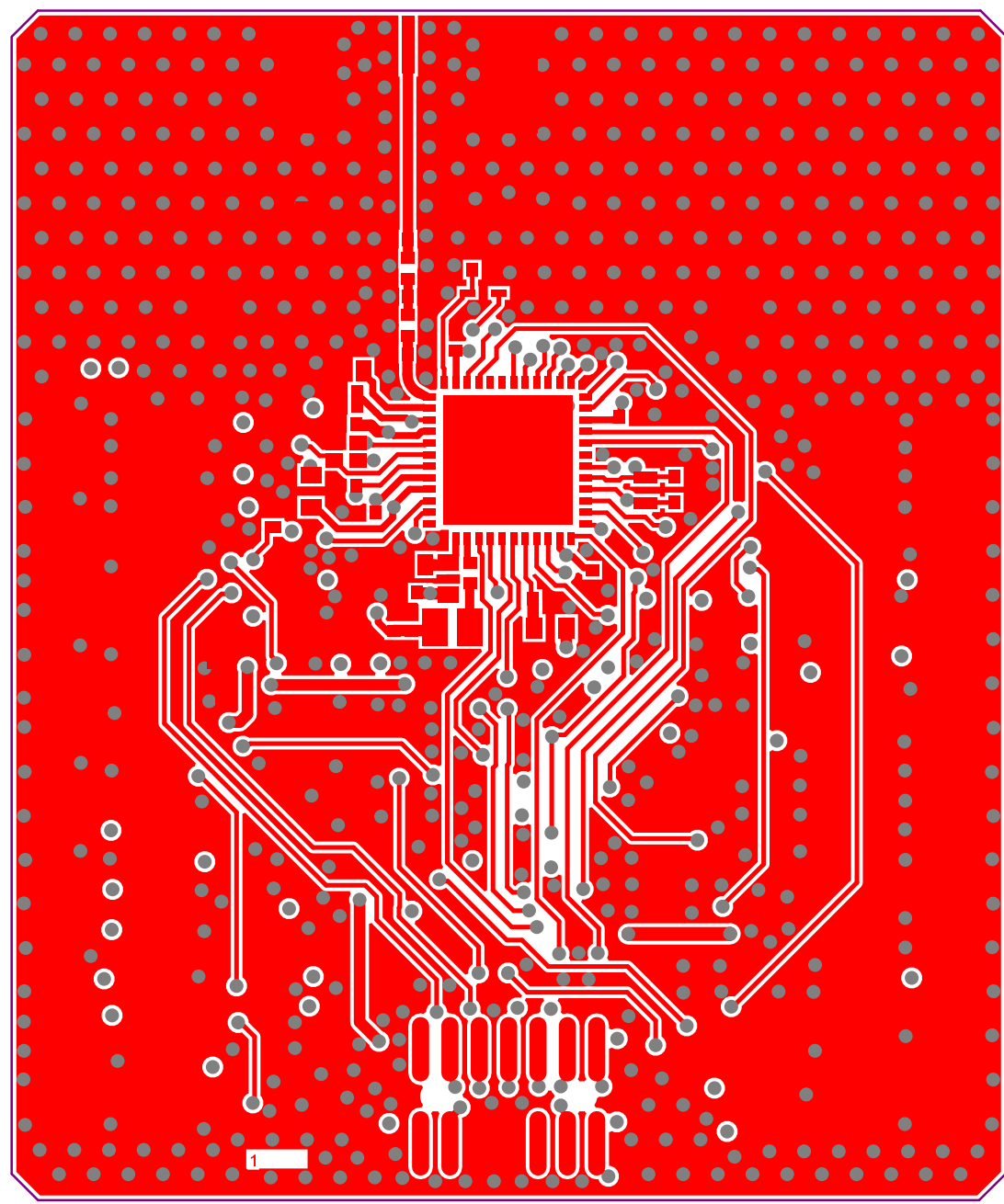
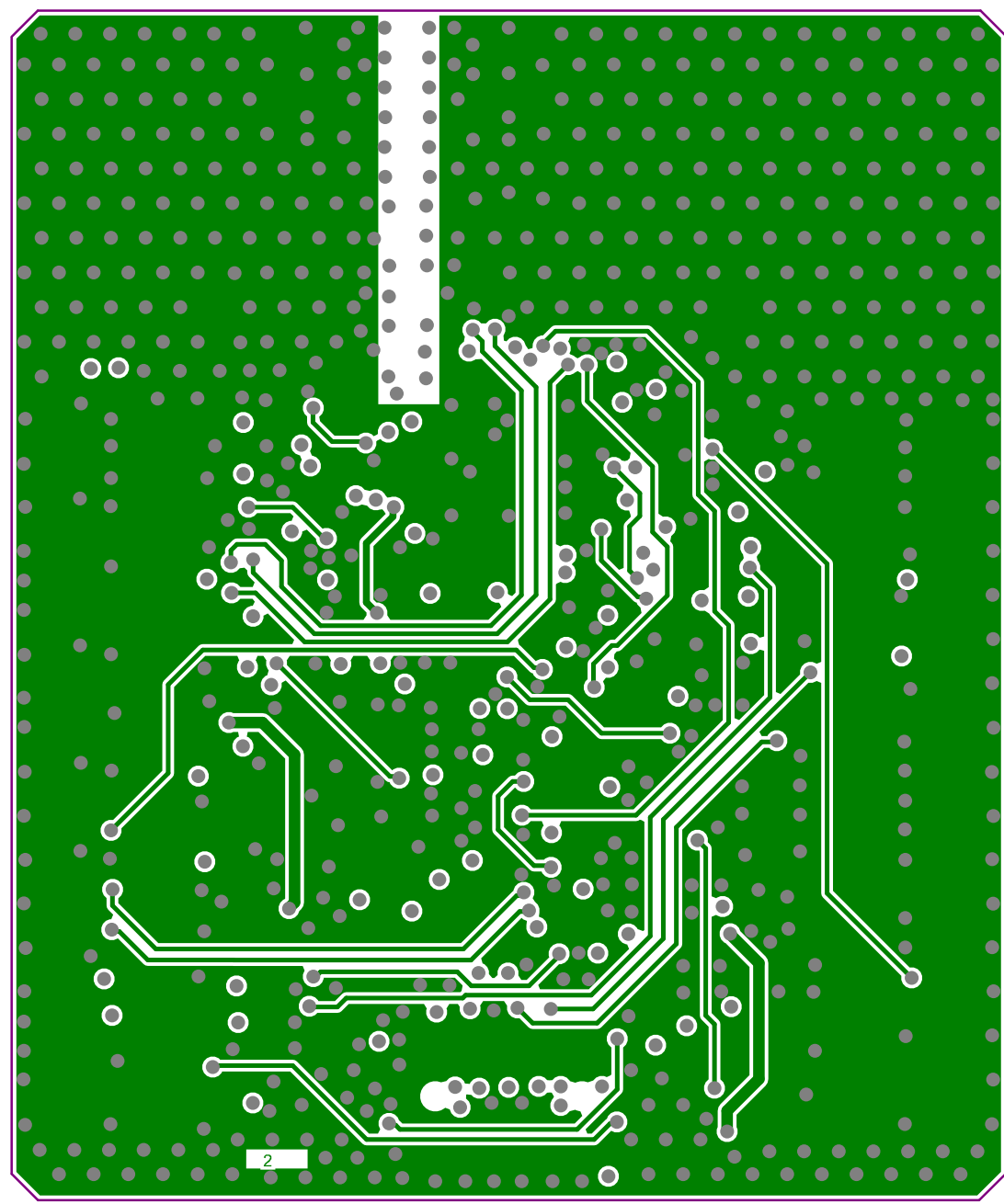
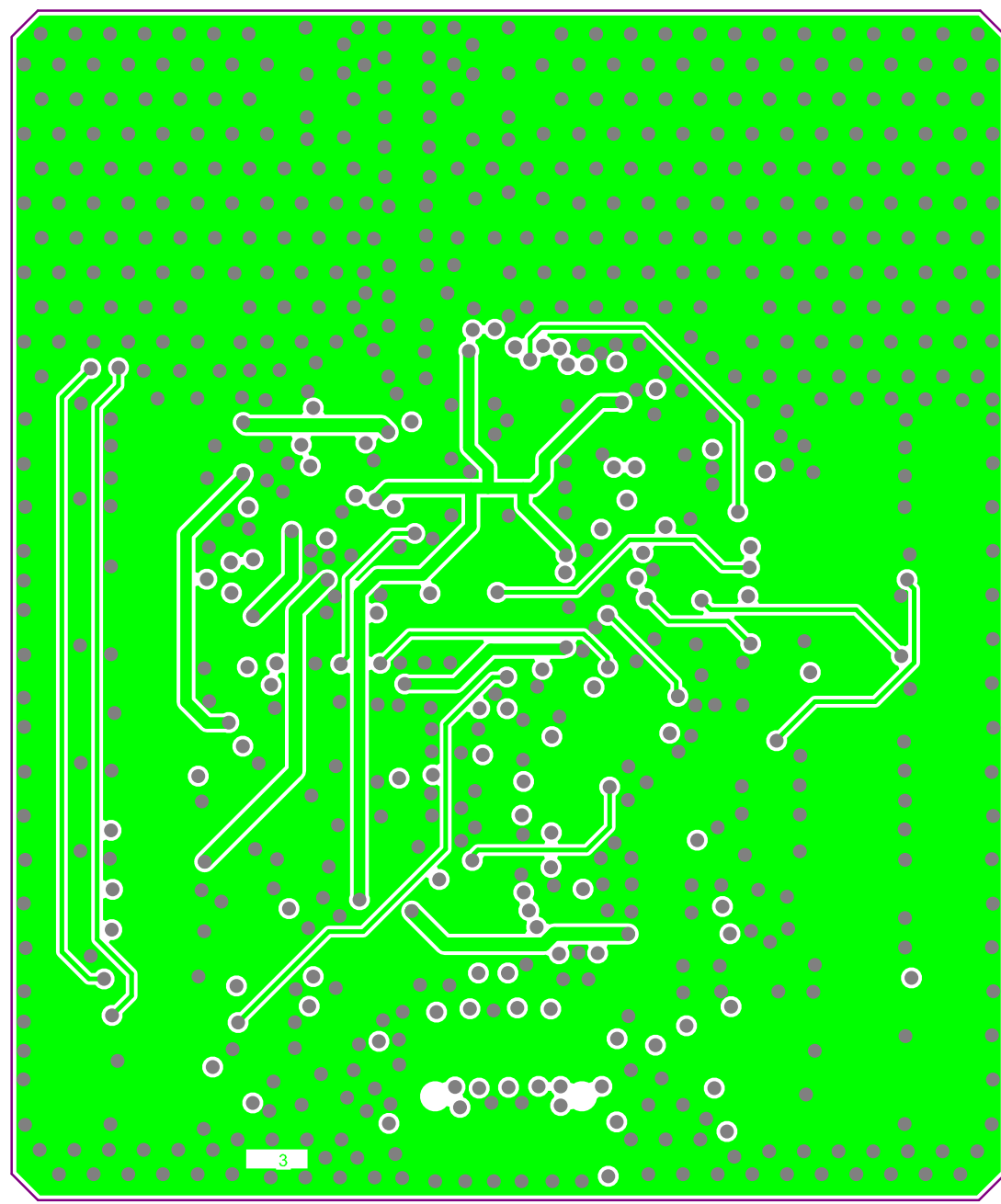


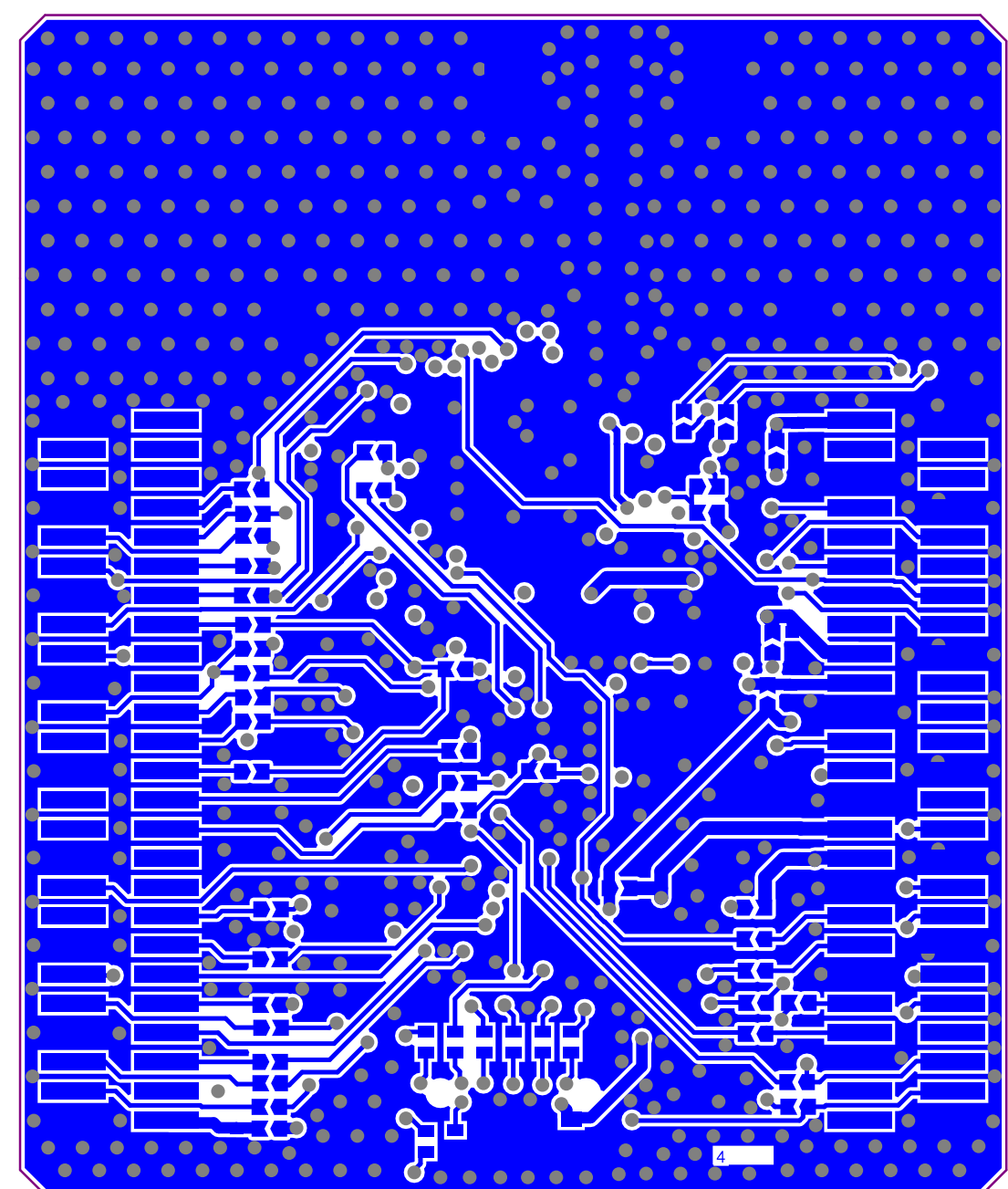


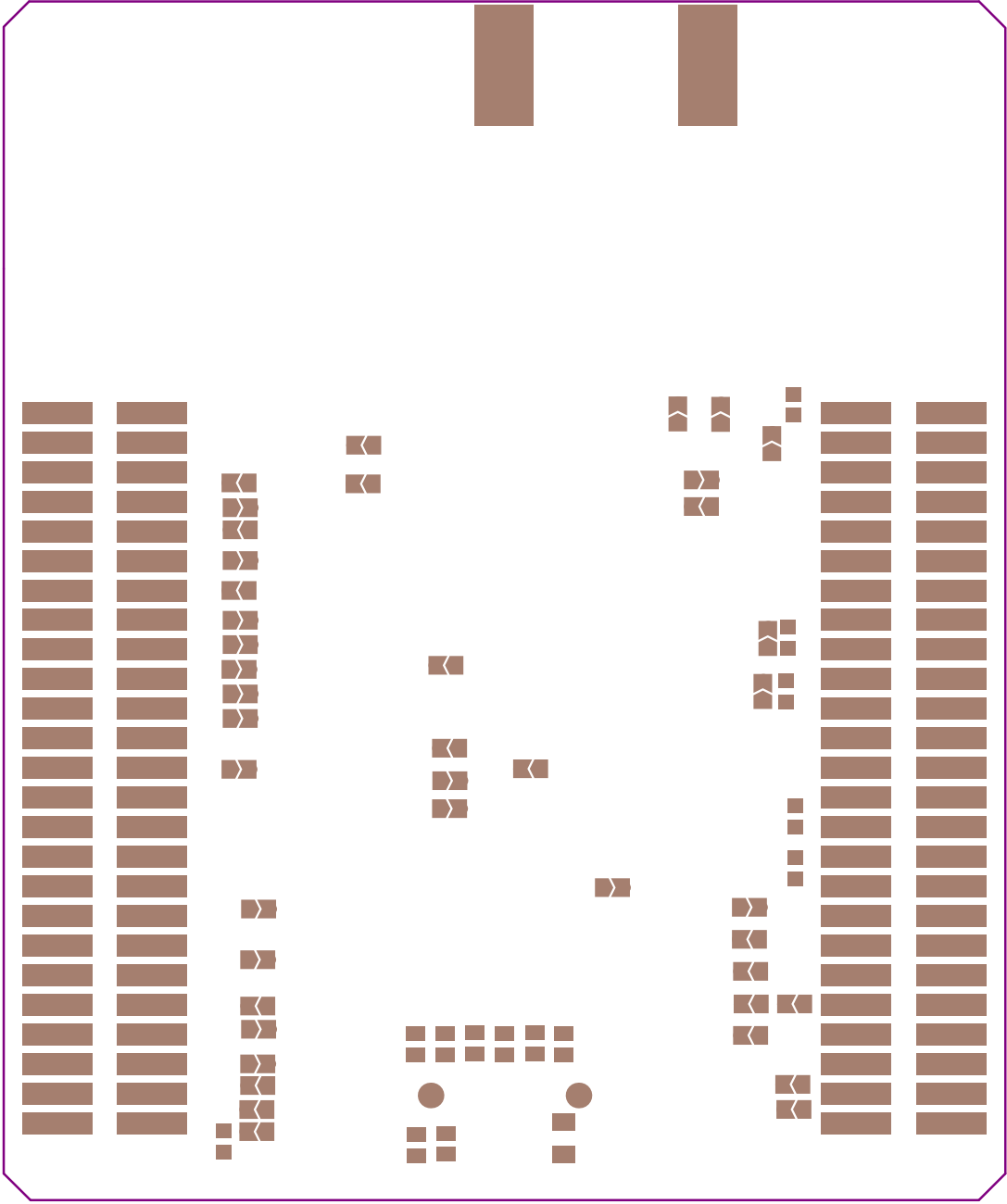






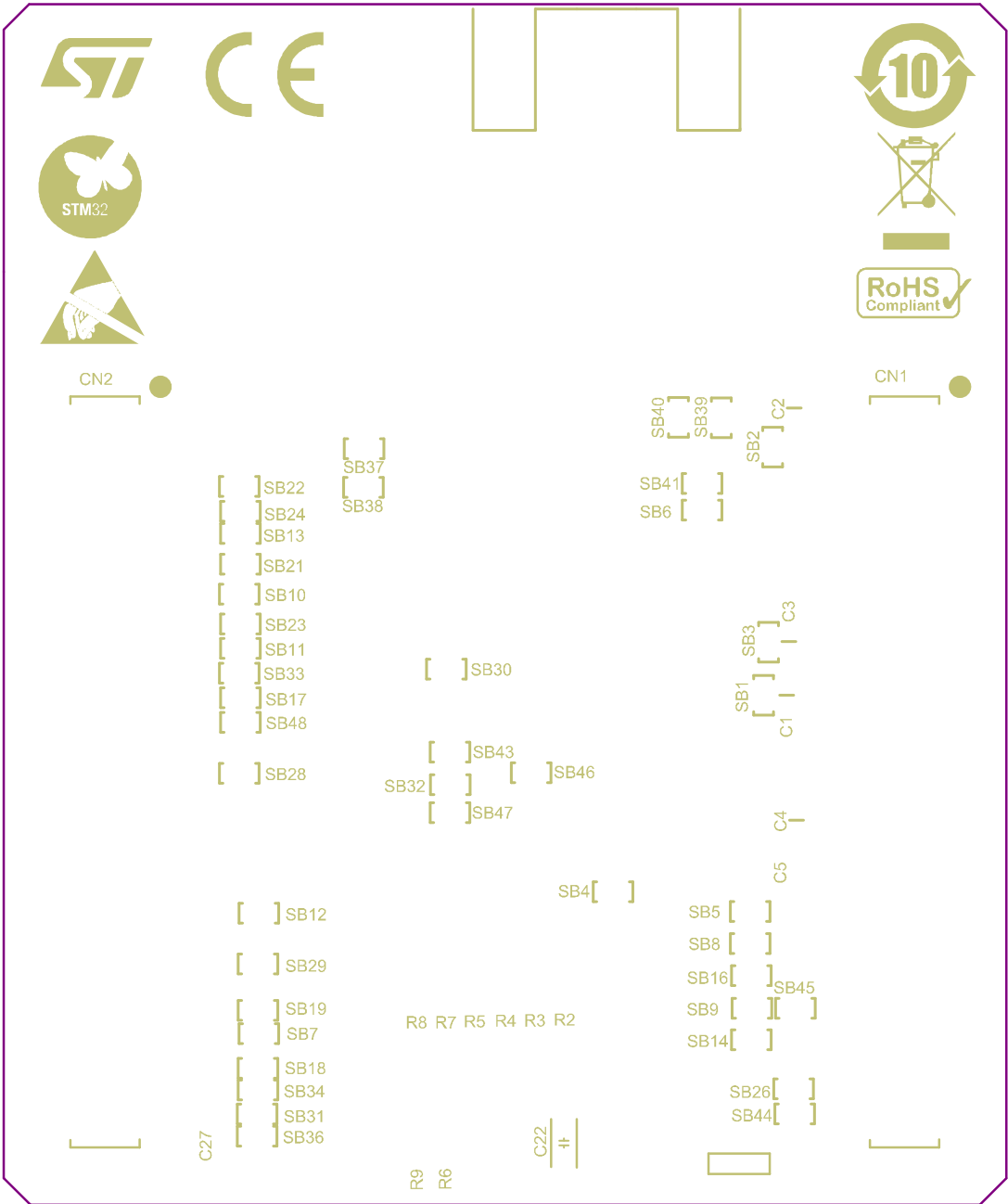






Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	Solder Resist	0,018mm	4.2	
1	Top Layer		0,041mm		
	Dielectric 1	FR-4	0,076mm	3.7	
2	Internal 1		0,030mm		
	Dielectric 3	FR-4	1,270mm	4.2	
3	Internal 2		0,030mm		
	Dielectric 2	FR-4	0,076mm	3.7	
4	Bottom Layer		0,041mm		
	Bottom Solder	Solder Resist	0,018mm	4.2	
	Bottom Overlay				

Total board thickness: 1,600mm



Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape	Template	Description	Hole Tolerance (+)	Hole Tolerance (-)
⊕	2	1.000mm (39.37mil)	NPTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c0hn100m110p0			
○	287	0.300mm (11.81mil)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	v60h30m0mx0(Tol1-2)_564437741		0.010mm (0.39mil)	0.020mm (0.79mil)
□	469	0.300mm (11.81mil)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	(Mixed)			
	758 Total										

